



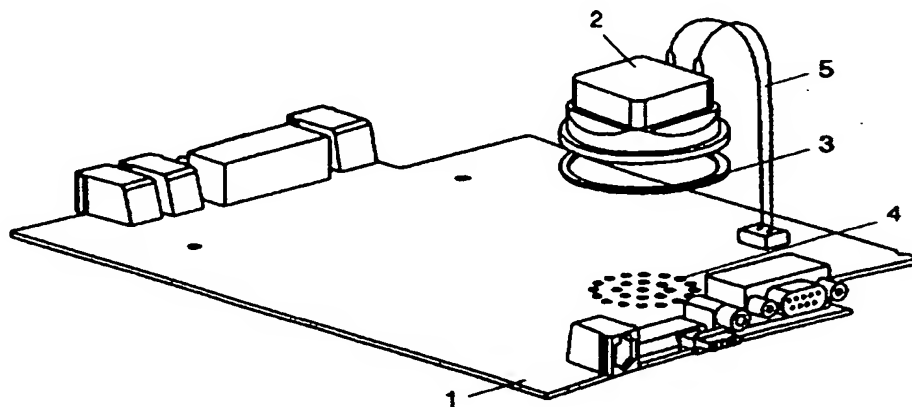
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(54) Title: A METHOD AND DEVICE TO FASTEN A LOUDSPEAKER TO A CIRCUIT BOARD



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(57) Abstract

With the intention of simplifying the manner in which a loudspeaker is mounted on a circuit board while maintaining requisite sealing and damping between the loudspeaker and the circuit board, the loudspeaker is affixed directly to the circuit board (1) by means of a double-side adhesive annulus (3) with the diaphragm of the loudspeaker facing towards the board, wherein the board has holes (4) located opposite the loudspeaker. The number of holes (4) provided and the size of the holes may be adapted to provide the best sound production in accordance with application. When a loudspeaker is mounted in this way, all components can be collected on the circuit board and therewith simplify manufacture of the telephone apparatus as such, irrespective of whether the circuit board is in the handset or some other part of the apparatus.

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A METHOD AND DEVICE TO FASTEN A LOUDSPEAKER TO A CIRCUIT BOARD

FIELD OF INVENTION

5 The present invention relates to a method of mounting at least one loudspeaker, and a loudspeaker mounting arranged in accordance with the method, for instance telephone handsets. Depending partly on their field of use, communications equipment may often include at least one microphone and at least one loudspeaker, which may be fixedly
10 mounted in the equipment.

DESCRIPTION OF THE BACKGROUND ART

There are several ways in which a loudspeaker can be fitted
15 to communications equipment. At present, the usual way is to mount the circuit board and loudspeaker separately in a plastic casing with some form of connection therebetween. The loudspeaker is most often suspended softly in a rubber for instance, so as to avoid resonances in a surrounding structure. In those instances when the loudspeakers are mounted
20 on circuit boards, the loudspeakers are always placed with their diaphragms facing away from the board. Loudspeaker mounting processes are required to be simple and inexpensive and the mounting shall fulfill the acoustic requirements
25 placed on the mounting.

DE-A1-3346461 teaches a method of mounting electroacoustic transducers on a conductor plate that has holes opposite the transducers.

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SE-B-451933 teaches a loudspeaker equipped arrangement in which the loudspeaker is mounted in a hole in the circuit board with the diaphragm facing away from the circuit board and with a vibration damping ring placed between the hole and
35 the loudspeaker.

DE-A1-3003714 teaches a telephone apparatus that has an electroacoustic transducer mounted on a circuit board.

SUMMARY OF THE INVENTION

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With the intention of simplifying the mounting of a loudspeaker on a circuit board in a telephone apparatus while still obtaining the requisite seal and damping between the loudspeaker and the board so as to achieve good sound
10 production, the loudspeaker has been affixed to the board with double adhesive tape with the diaphragm facing towards the board, which has at least one hole located opposite the loudspeaker. The number of holes provided and the size of
15 said holes can be adapted to provide the best sound production, depending on application. With this type of loudspeaker mounting, all components can be collected on the board, therewith simplifying manufacture of the telephone apparatus as such, irrespective of whether the circuit board is in the handheld (receiver) part of the telephone apparatus or in
20 some other part thereof.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 shows a stage in an inventive loudspeaker mounting
25 process prior to mounting the loudspeaker.

Figure 2 shows an inventive loudspeaker mounting.

DETAILED DESCRIPTION OF A PREFERRED EMBODIMENT

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Figure 1 is a simplified illustration of a telephone apparatus circuit board 1 that has an integrated loudspeaker circuit. A loudspeaker 2 is shown in a position prior to lowering and affixing the loudspeaker onto the circuit board
35 1. Located between the loudspeaker and the circuit board is a flat ring 3 which may be comprised of elastic double-adhesive material, such as elastic double adhesive tape. The

circuit board is perforated with holes 4 in the region beneath the loudspeaker for production of loudspeaker sound. The loudspeaker is connected electrically to the circuit board by twin conductors 5. In the illustrated case, the means by which the necessary seal against the board and the transmission of occurrent mechanical vibrations are dampened has the form of an adhesive tape annulus.

Figure 2 shows the loudspeaker firmly mounted on the circuit board with the aid of the adhesive tape annulus, with the loudspeaker diaphragm facing towards the board in the region of the holes 4.

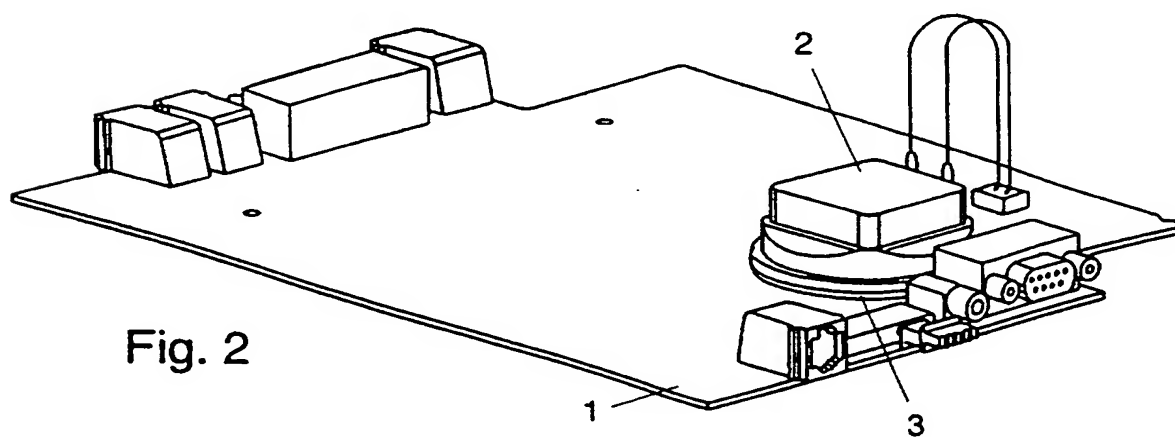
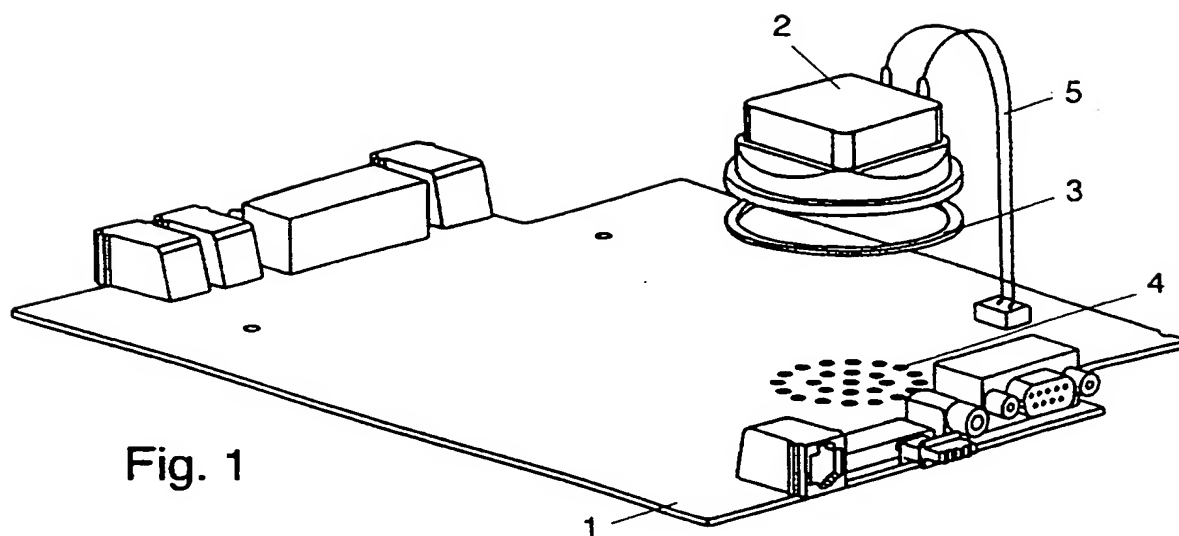
The actual procedure of mounting the loudspeaker on the board is preceded by securing an adhesive annulus 3 to the board 1 after having positioned the annulus in accordance with markings on the board. When the annulus has been fixed in position, the loudspeaker 2 is pressed onto the annulus. It has been found that the bond afforded by a double adhesive annulus, ie an annulus that is adhesive on both sides, is sufficiently strong to resist comprehensive shaking forces, without requiring the assistance of additional fasteners such as screws to this end. Mounting of the loudspeaker is thus a relatively simple process that requires no further connecting means. When the tape used is more or less elastic, it can be used as a soft loudspeaker suspension, therewith obviating the need to use typical rubber packings to this end. The use of hard and non-elastic material is also conceivable, although this use will depend on the application of the invention. When the loudspeaker is mounted in accordance with the invention, the circuit board 1 can be used as a baffle to produce a high sound volume. The holes 4 in the circuit board may also be optimized with respect to prevailing acoustic requirements. The loudspeaker may be mounted on the same side as or on the opposite to other board mounted components, depending on use.

In the case of conference telephones, loudspeaking telephones or a telephone apparatus having a call distribution function, a switching center for instance, the loudspeaker may be placed facing down towards or facing upwardly away from an underlying supportive surface and intended to deliver acoustic signal and also speech signals. For instance, the wiring of a fixed or a mobile telephone apparatus having a circuit board in a combined transceiver unit that includes components and keypad will be greatly simplified when the loudspeaker is mounted directly on the circuit board, said board including sound production holes opposite the loudspeaker diaphragm. Wiring between loudspeaker and remaining circuit components is simplified when the loudspeaker is mounted in the aforesaid manner. The entire electronic unit may consist in one single board when the loudspeaker circuit is integrated in this way.

CLAIMS

- 1 A method of mounting at least one loudspeaker in communica-
tions equipment, characterized by securing the loudspeaker
5 to the perforated circuit board with the aid of an annulus
comprised of double-sided adhesive material, such as double-
sided adhesive tape, located between the loudspeaker and the
circuit board, with the diaphragm of the loudspeaker facing
towards circuit board.
- 10 2. A loudspeaker mounting means for mounting at least one
loudspeaker in communications equipment, characterized in
that the loudspeaker (2) is intended to be affixed to circuit
board perforated with holes (4) with the aid of an annulus
15 (3) comprised of double-sided adhesive material, such as
double-sided adhesive tape, located between the loudspeaker
and the circuit board, with the diaphragm of the loudspeaker
facing towards circuit board.
- 20 3. A mounting means according to Claim 2, characterized in
that the adhesive material (3) is soft and elastic.
4. A mounting means according to Claim 2, characterized in
that the adhesive material (3) is hard and non-elastic.

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INTERNATIONAL SEARCH REPORT

International application No.

PCT/SE 96/01376

A. CLASSIFICATION OF SUBJECT MATTER

IPC6: H04M 1/02

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC6: H04M, H04R

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

SE,DK,FI,NO classes as above

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

C. DOCUMENTS CONSIDERED TO BE RELEVANT

| Category* | Citation of document, with indication, where appropriate, of the relevant passages | Relevant to claim No. |
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| X | WO 8503613 A1 (GNT AUTOMATIC A/S), 15 August 1985 (15.08.85), page 14, line 20 - page 16, line 3, figures 1-11, abstract -- | 1-4 |
| Y | DE 3346461 A1 (SIEMENS AG), 4 July 1985 (04.07.85), page 5, column 34 - page 6, line 1, figures 1-3, abstract -- | 1-4 |
| Y | EP 0218832 A1 (SIEMENS AKTIENGESELLSCHAFT BERLIN UND MÜNCHEN), 22 April 1987 (22.04.87), figures 1-3, claim 6, abstract -- | 1-4 |

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Roland Landström
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| A | SE 451933 A (ELLEMTTEL UTVECKLINGS AB), 2 November 1987 (02.11.87), page 3, line 6 - line 9, figures 1-3, abstract -- | 1-4 |
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INTERNATIONAL SEARCH REPORT

Information on patent family members

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| EP-A1- 0218832 | 22/04/87 | JP-A- 62081719 US-A- 4864471 | 15/04/87 05/09/89 |
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